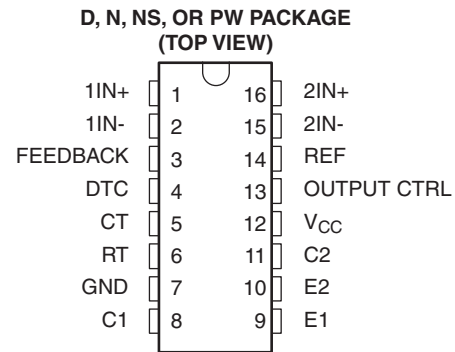


FEATURES

- Complete PWM Power-Control Circuitry
- Uncommitted Outputs for 200-mA Sink or Source Current
- Output Control Selects Single-Ended or Push-Pull Operation
- Internal Circuitry Prohibits Double Pulse at Either Output
- Variable Dead Time Provides Control Over Total Range
- Internal Regulator Provides a Stable 5-V Reference Supply Trimmed to 1%
- Circuit Architecture Allows Easy Synchronization
- Undervoltage Lockout for Low- V_{CC} Conditions



DESCRIPTION/ORDERING INFORMATION

The TL594 incorporates all the functions required in the construction of a pulse-width-modulation (PWM) control circuit on a single chip. Designed primarily for power-supply control, this device offers the systems engineer the flexibility to tailor the power-supply control circuitry to a specific application.

The TL594 contains two error amplifiers, an on-chip adjustable oscillator, a dead-time control (DTC) comparator, a pulse-steering control flip-flop, a 5-V regulator with a precision of 1%, an undervoltage lockout control circuit, and output control circuitry.

The error amplifiers have a common-mode voltage range of -0.3 V to $V_{CC} - 2\text{ V}$. The DTC comparator has a fixed offset that provides approximately 5% dead time. The on-chip oscillator can be bypassed by terminating RT to the reference output and providing a sawtooth input to CT, or it can be used to drive the common circuitry in synchronous multiple-rail power supplies.

The uncommitted output transistors provide either common-emitter or emitter-follower output capability. Each device provides for push-pull or single-ended output operation, with selection by means of the output-control function. The architecture of these devices prohibits the possibility of either output being pulsed twice during push-pull operation. The undervoltage lockout control circuit locks the outputs off until the internal circuitry is operational.

The TL594C is characterized for operation from 0°C to 70°C . The TL594I is characterized for operation from -40°C to 85°C .



Please be aware that an important notice concerning availability, standard warranty, and use in critical applications of Texas Instruments semiconductor products and disclaimers thereto appears at the end of this data sheet.

TL594

PULSE-WIDTH-MODULATION CONTROL CIRCUIT

SLVS052G–APRIL 1988–REVISED JANUARY 2007

ORDERING INFORMATION⁽¹⁾

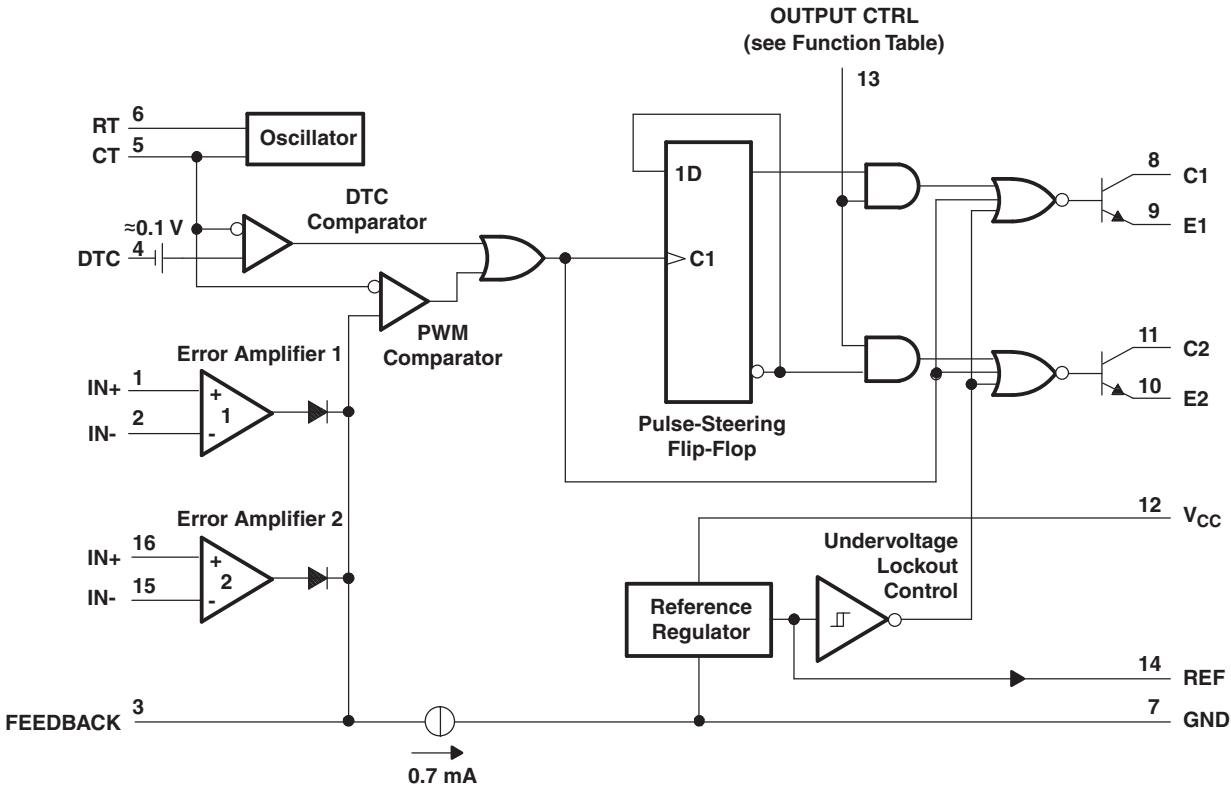
| T _A | PACKAGE ⁽²⁾ | | ORDERABLE PART NUMBER | TOP-SIDE MARKING |
|----------------|------------------------|--------------|-----------------------|------------------|
| 0°C to 70°C | PDIP – N | Tube of 25 | TL594CN | TL594CN |
| | SOIC – D | Tube of 40 | TL594CD | TL594C |
| | | Reel of 2500 | TL594CDR | |
| | SOP – NS | Reel of 2000 | TL594CNSR | TL594 |
| | TSSOP – PW | Tube of 90 | TL594CPW | T594 |
| | | Reel of 2000 | TL594CPWR | |
| –40°C to 85°C | PDIP – N | Tube of 25 | TL594IN | TL594IN |
| | SOIC – D | Tube of 40 | TL594ID | TL594I |
| | | Reel of 2500 | TL594IDR | |
| | SOP – NS | Reel of 2000 | TL594INSR | TL594I |
| | TSSOP – PW | Tube of 90 | TL594IPW | Z594 |
| | | Reel of 2000 | TL594IPWR | |

- (1) For the most current package and ordering information, see the Package Option Addendum at the end of this document, or see the TI web site at www.ti.com.
 (2) Package drawings, standard packing quantities, thermal data, symbolization, and PCB design guidelines are available at www.ti.com/sc/package.

FUNCTION TABLE

| INPUT | OUTPUT FUNCTION |
|-----------------------------------|---------------------------------|
| OUTPUT CTRL | |
| V _I = 0 | Single-ended or parallel output |
| V _I = V _{ref} | Normal push-pull operation |

FUNCTIONAL BLOCK DIAGRAM



ABSOLUTE MAXIMUM RATINGS⁽¹⁾

over operating free-air temperature range (unless otherwise noted)

| | | VALUE | UNIT |
|---------------|---|----------------|------|
| V_{CC} | Supply voltage ⁽²⁾ | 41 | V |
| | Amplifier input voltage | $V_{CC} + 0.3$ | V |
| | Collector output voltage | 41 | V |
| | Collector output current | 250 | mA |
| θ_{JA} | Package thermal impedance ⁽³⁾⁽⁴⁾ | D package | 73 |
| | | N package | 67 |
| | | NS package | 64 |
| | | PW package | 108 |
| T_J | Operating virtual junction temperature | 150 | °C |
| T_{stg} | Storage temperature range | –65 to 150 | °C |

(1) Stresses beyond those listed under “absolute maximum ratings” may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under “recommended operating conditions” is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

(2) All voltage values, except differential voltages, are with respect to the network ground terminal.

(3) Maximum power dissipation is a function of $T_J(\text{max})$, θ_{JA} , and T_A . The maximum allowable power dissipation at any allowable ambient temperature is $P_D = (T_J(\text{max}) - T_A)/\theta_{JA}$. Operating at the absolute maximum T_J of 150°C can affect reliability.

(4) The package thermal impedance is calculated in accordance with JESD 51-7.

RECOMMENDED OPERATING CONDITIONS

| | | MIN | MAX | UNIT |
|-----------|--|--------|--------------|------------|
| V_{CC} | Supply voltage | 7 | 40 | V |
| V_I | Amplifier input voltage | –0.3 | $V_{CC} - 2$ | V |
| V_O | Collector output voltage | | 40 | V |
| | Collector output current (each transistor) | | 200 | mA |
| | Current into FEEDBACK terminal | | 0.3 | mA |
| C_T | Timing capacitor | 0.47 | 10000 | nF |
| R_T | Timing resistor | 1.8 | 500 | k Ω |
| f_{osc} | Oscillator frequency | 1 | 300 | kHz |
| T_A | Operating free-air temperature | TL594C | 0 | 70 |
| | | TL594I | –40 | 85 |

ELECTRICAL CHARACTERISTICS

$V_{CC} = 15\text{ V}$, over recommended operating free-air temperature range (unless otherwise noted)

| PARAMETER | TEST CONDITIONS ⁽¹⁾ | MIN | TYP ⁽²⁾ | MAX | UNIT |
|---|--|----------------------------|--------------------|------|--------|
| Reference Section | | | | | |
| Output voltage (REF) | I _O = 1 mA, T _A = 25°C | 4.95 | 5 | 5.05 | V |
| Input regulation | V _{CC} = 7 V to 40 V, T _A = 25°C | | 2 | 25 | mV |
| Output regulation | I _O = 1 mA to 10 mA, T _A = 25°C | | 14 | 35 | mV |
| Output-voltage change with temperature | ΔT _A = MIN to MAX | | 2 | 10 | mV/V |
| Short-circuit output current ⁽³⁾ | V _{ref} = 0 | 10 | 35 | 50 | mA |
| Amplifier Section (see Figure 1) | | | | | |
| Input offset voltage, error amplifier | FEEDBACK = 2.5 V | | 2 | 10 | mV |
| Input offset current | FEEDBACK = 2.5 V | | 25 | 250 | nA |
| Input bias current | FEEDBACK = 2.5 V | | 0.2 | 1 | μA |
| Common-mode input voltage range, error amplifier | V _{CC} = 7 V to 40 V | 0.3 to V _{CC} – 2 | | | V |
| Open-loop voltage amplification, error amplifier | ΔV _O = 3 V, R _L = 2 kΩ, V _O = 0.5 V to 3.5 V | 70 | 95 | | dB |
| Unity-gain bandwidth | V _O = 0.5 V to 3.5 V, R _L = 2 kΩ | | 800 | | kHz |
| Common-mode rejection ratio, error amplifier | V _{CC} = 40 V, T _A = 25°C | 65 | 80 | | dB |
| Output sink current, FEEDBACK | V _{ID} = –15 mV to –5 V, FEEDBACK = 0.5 V | 0.3 | 0.7 | | mA |
| Output source current, FEEDBACK | V _{ID} = 15 mV to 5 V, FEEDBACK = 3.5 V | –2 | | | mA |
| Oscillator Section, C _T = 0.01 μF, R _T = 12 kΩ (see Figure 2) | | | | | |
| Frequency | | | 10 | | kHz |
| Standard deviation of frequency ⁽⁴⁾ | All values of V _{CC} , C _T , R _T , and T _A constant | | 100 | | Hz/kHz |
| Frequency change with voltage | V _{CC} = 7 V to 40 V, T _A = 25°C | | 1 | | Hz/kHz |
| Frequency change with temperature ⁽⁵⁾ | ΔT _A = MIN to MAX | | | 50 | Hz/kHz |
| Dead-Time Control Section (see Figure 2) | | | | | |
| Input bias current | V _I = 0 to 5.25 V | | –2 | –10 | μA |
| Maximum duty cycle, each output | DTC = 0 V | 0.45 | | | |
| Input threshold voltage | Zero duty cycle | | 3 | 3.3 | V |
| | Maximum duty cycle | 0 | | | |
| Output Section | | | | | |
| Collector off-state current | V _C = 40 V, V _E = 0 V, V _{CC} = 40 V | | 2 | 100 | μA |
| | DTC and OUTPUT CTRL = 0 V, V _C = 15 V, V _E = 0 V, V _{CC} = 1 V to 3 V | | 4 | 200 | |
| Emitter off-state current | V _{CC} = V _C = 40 V, V _E = 0 | | | –100 | μA |
| Collector-emitter saturation voltage | Common emitter, V _E = 0, I _C = 200 mA | | 1.1 | 1.3 | V |
| | Emitter follower, V _C = 15 V, I _E = –200 mA | | 1.5 | 2.5 | |
| Output control input current | V _I = V _{ref} | | | 3.5 | mA |

(1) For conditions shown as MIN or MAX, use the appropriate value specified under recommended operating conditions.

(2) All typical values, except for parameter changes with temperature, are at $T_A = 25^\circ\text{C}$.

(3) Duration of the short circuit should not exceed one second.

(4) Standard deviation is a measure of the statistical distribution about the mean, as derived from the formula:

$$\sigma = \sqrt{\frac{\sum_{n=1}^N (x_n - \bar{X})^2}{N - 1}}$$

(5) Temperature coefficient of timing capacitor and timing resistor is not taken into account.

ELECTRICAL CHARACTERISTICS (continued)

$V_{CC} = 15\text{ V}$, over recommended operating free-air temperature range (unless otherwise noted)

| PARAMETER | TEST CONDITIONS ⁽¹⁾ | MIN | TYP ⁽²⁾ | MAX | UNIT |
|--|---|------------------------|--------------------|-----|------|
| PWM Comparator Section (see Figure 2) | | | | | |
| Input threshold voltage, FEEDBACK | Zero duty cycle | | 4 | 4.5 | V |
| Input sink current, FEEDBACK | FEEDBACK = 0.5 V | 0.3 | 0.7 | | mA |
| Undervoltage Lockout Section (see Figure 2) | | | | | |
| Threshold voltage | $T_A = 25^\circ\text{C}$ | | | 6 | V |
| | $\Delta T_A = \text{MIN to MAX}$ | 3.5 | | 6.9 | |
| Hysteresis ⁽⁶⁾ | | 100 | | | mV |
| Overall Device | | | | | |
| Standby supply current | R_T at V_{ref} , All other inputs and outputs open | $V_{CC} = 15\text{ V}$ | 9 | 15 | mA |
| | | $V_{CC} = 40\text{ V}$ | 11 | 18 | |
| Average supply current | DTC = 2 V, See Figure 2 | | 12.4 | | mA |

(6) Hysteresis is the difference between the positive-going input threshold voltage and the negative-going input threshold voltage.

SWITCHING CHARACTERISTICS

$V_{CC} = 15\text{ V}$, $T_A = 25^\circ\text{C}$, over recommended operating conditions (unless otherwise noted)

| PARAMETER | TEST CONDITIONS | MIN | TYP | MAX | UNIT |
|--------------------------|---|-----|-----|-----|------|
| Output-voltage rise time | Common-emitter configuration (see Figure 3) | | 100 | 200 | ns |
| Output-voltage fall time | | | 30 | 100 | ns |
| Output-voltage rise time | Emitter-follower configuration (see Figure 4) | | 200 | 400 | ns |
| Output-voltage fall time | | | 45 | 100 | ns |

PARAMETER MEASUREMENT INFORMATION

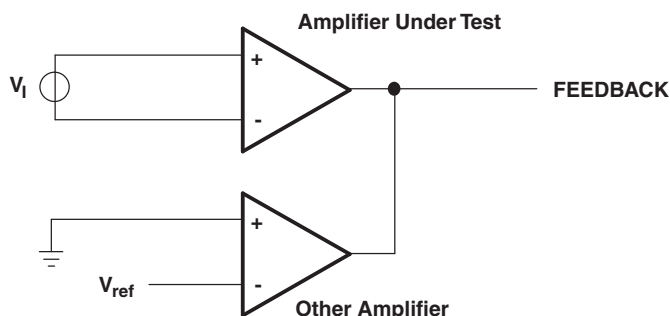


Figure 1. Amplifier-Characteristics Test Circuit

PARAMETER MEASUREMENT INFORMATION (continued)

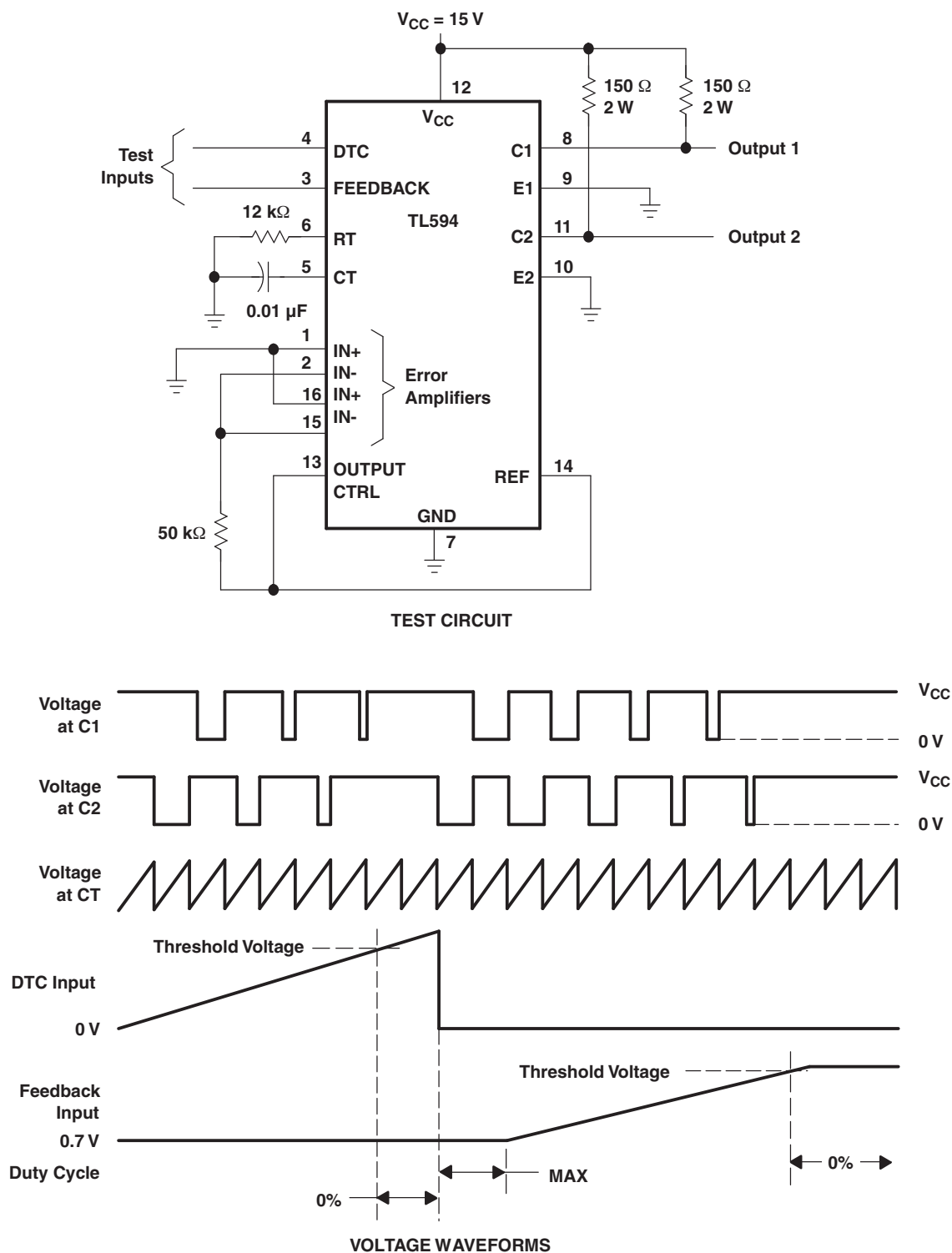


Figure 2. Operational Test Circuit and Waveforms

PARAMETER MEASUREMENT INFORMATION (continued)

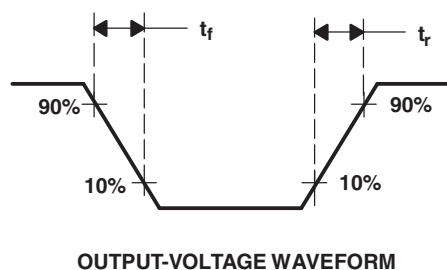
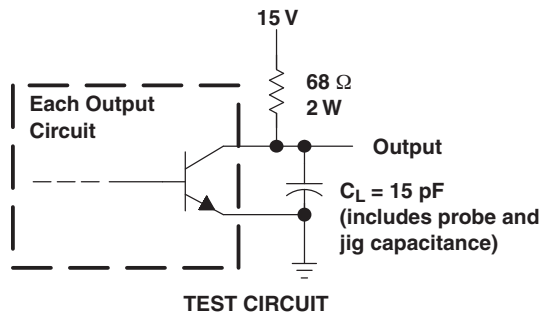


Figure 3. Common-Emitter Configuration

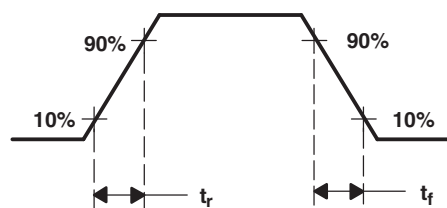
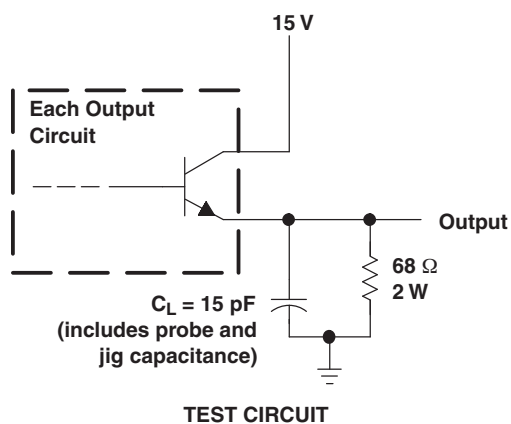
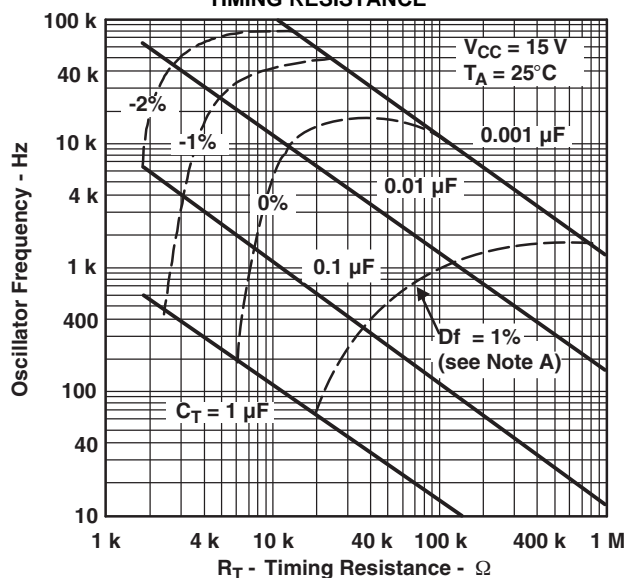


Figure 4. Emitter-Follower Configuration

TYPICAL CHARACTERISTICS
OSCILLATOR FREQUENCY AND FREQUENCY VARIATION^(A)
vs
TIMING RESISTANCE



A. Frequency variation (Δf) is the change in oscillator frequency that occurs over the full temperature range.

Figure 5.

AMPLIFIER VOLTAGE AMPLIFICATION
vs
FREQUENCY

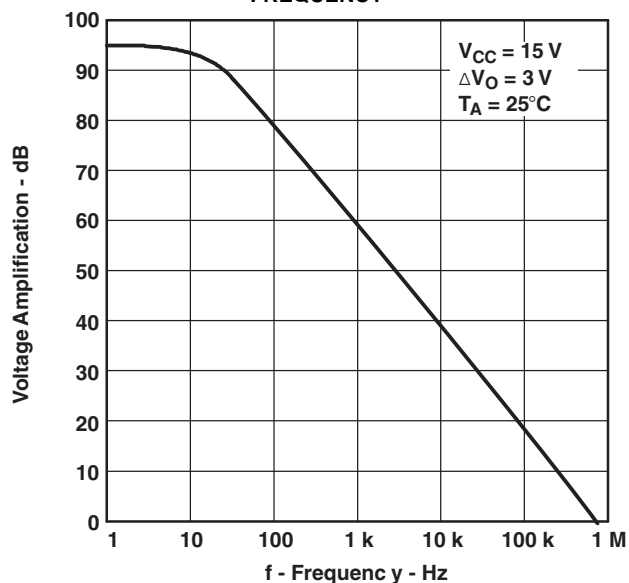


Figure 6.

APPLICATION INFORMATION

How to Set Dead Time

The primary function of the dead-time control is to control the minimum off time of the output of the TL594. The dead-time control input provides control from 5% to 100% dead time. The TL594 can be tailored to the specific power transistor switches that are used, to ensure that the output transistors never experience a common on-time. The bias circuit for the basic function is shown in [Figure 7](#).

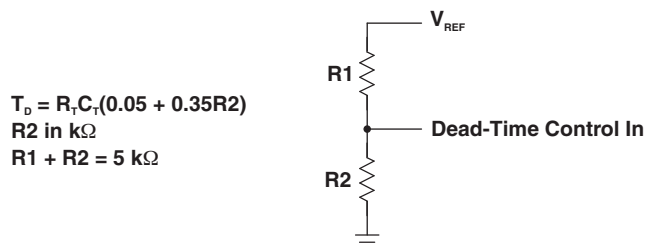


Figure 7. Setting Dead Time

PACKAGING INFORMATION

| Orderable Device | Status (1) | Package Type | Package Drawing | Pins | Package Qty | Eco Plan (2) | Lead/Ball Finish | MSL Peak Temp (3) | Op Temp (°C) | Top-Side Markings (4) | Samples |
|------------------|---------------|--------------|--------------------|------|----------------|----------------------------|------------------|----------------------|--------------|--------------------------|-------------------------|
| TL594CD | ACTIVE | SOIC | D | 16 | 40 | Green (RoHS & no Sb/Br) | CU NIPDAU | Level-1-260C-UNLIM | 0 to 70 | TL594C | Samples |
| TL594CDE4 | ACTIVE | SOIC | D | 16 | 40 | Green (RoHS & no Sb/Br) | CU NIPDAU | Level-1-260C-UNLIM | 0 to 70 | TL594C | Samples |
| TL594CDG4 | ACTIVE | SOIC | D | 16 | 40 | Green (RoHS & no Sb/Br) | CU NIPDAU | Level-1-260C-UNLIM | 0 to 70 | TL594C | Samples |
| TL594CDR | ACTIVE | SOIC | D | 16 | 2500 | Green (RoHS & no Sb/Br) | CU NIPDAU | Level-1-260C-UNLIM | 0 to 70 | TL594C | Samples |
| TL594CDRE4 | ACTIVE | SOIC | D | 16 | 2500 | Green (RoHS & no Sb/Br) | CU NIPDAU | Level-1-260C-UNLIM | 0 to 70 | TL594C | Samples |
| TL594CDRG3 | PREVIEW | SOIC | D | 16 | | TBD | Call TI | Call TI | 0 to 70 | TL594C | |
| TL594CDRG4 | ACTIVE | SOIC | D | 16 | 2500 | Green (RoHS & no Sb/Br) | CU NIPDAU | Level-1-260C-UNLIM | 0 to 70 | TL594C | Samples |
| TL594CN | ACTIVE | PDIP | N | 16 | 25 | Pb-Free (RoHS) | CU NIPDAU | N / A for Pkg Type | 0 to 70 | TL594CN | Samples |
| TL594CNE4 | ACTIVE | PDIP | N | 16 | 25 | Pb-Free (RoHS) | CU NIPDAU | N / A for Pkg Type | 0 to 70 | TL594CN | Samples |
| TL594CNSR | ACTIVE | SO | NS | 16 | 2000 | Green (RoHS & no Sb/Br) | CU NIPDAU | Level-1-260C-UNLIM | 0 to 70 | TL594 | Samples |
| TL594CNSRE4 | ACTIVE | SO | NS | 16 | 2000 | Green (RoHS & no Sb/Br) | CU NIPDAU | Level-1-260C-UNLIM | 0 to 70 | TL594 | Samples |
| TL594CNSRG4 | ACTIVE | SO | NS | 16 | 2000 | Green (RoHS & no Sb/Br) | CU NIPDAU | Level-1-260C-UNLIM | 0 to 70 | TL594 | Samples |
| TL594CPW | ACTIVE | TSSOP | PW | 16 | 90 | Green (RoHS & no Sb/Br) | CU NIPDAU | Level-1-260C-UNLIM | 0 to 70 | T594 | Samples |
| TL594CPWE4 | ACTIVE | TSSOP | PW | 16 | 90 | Green (RoHS & no Sb/Br) | CU NIPDAU | Level-1-260C-UNLIM | 0 to 70 | T594 | Samples |
| TL594CPWG4 | ACTIVE | TSSOP | PW | 16 | 90 | Green (RoHS & no Sb/Br) | CU NIPDAU | Level-1-260C-UNLIM | 0 to 70 | T594 | Samples |
| TL594CPWR | ACTIVE | TSSOP | PW | 16 | 2000 | Green (RoHS & no Sb/Br) | CU NIPDAU | Level-1-260C-UNLIM | 0 to 70 | T594 | Samples |
| TL594CPWRE4 | ACTIVE | TSSOP | PW | 16 | 2000 | Green (RoHS & no Sb/Br) | CU NIPDAU | Level-1-260C-UNLIM | 0 to 70 | T594 | Samples |

| Orderable Device | Status (1) | Package Type | Package Drawing | Pins | Package Qty | Eco Plan (2) | Lead/Ball Finish | MSL Peak Temp (3) | Op Temp (°C) | Top-Side Markings (4) | Samples |
|------------------|---------------|--------------|--------------------|------|----------------|----------------------------|------------------|----------------------|--------------|--------------------------|-------------------------|
| TL594CPWRG4 | ACTIVE | TSSOP | PW | 16 | 2000 | Green (RoHS & no Sb/Br) | CU NIPDAU | Level-1-260C-UNLIM | 0 to 70 | T594 | Samples |
| TL594ID | ACTIVE | SOIC | D | 16 | 40 | Green (RoHS & no Sb/Br) | CU NIPDAU | Level-1-260C-UNLIM | -40 to 85 | TL594I | Samples |
| TL594IDE4 | ACTIVE | SOIC | D | 16 | 40 | Green (RoHS & no Sb/Br) | CU NIPDAU | Level-1-260C-UNLIM | -40 to 85 | TL594I | Samples |
| TL594IDG4 | ACTIVE | SOIC | D | 16 | 40 | Green (RoHS & no Sb/Br) | CU NIPDAU | Level-1-260C-UNLIM | -40 to 85 | TL594I | Samples |
| TL594IDR | ACTIVE | SOIC | D | 16 | 2500 | Green (RoHS & no Sb/Br) | CU NIPDAU | Level-1-260C-UNLIM | -40 to 85 | TL594I | Samples |
| TL594IDRE4 | ACTIVE | SOIC | D | 16 | 2500 | Green (RoHS & no Sb/Br) | CU NIPDAU | Level-1-260C-UNLIM | -40 to 85 | TL594I | Samples |
| TL594IDRG4 | ACTIVE | SOIC | D | 16 | 2500 | Green (RoHS & no Sb/Br) | CU NIPDAU | Level-1-260C-UNLIM | -40 to 85 | TL594I | Samples |
| TL594IN | ACTIVE | PDIP | N | 16 | 25 | Pb-Free (RoHS) | CU NIPDAU | N / A for Pkg Type | -40 to 85 | TL594IN | Samples |
| TL594INE4 | ACTIVE | PDIP | N | 16 | 25 | Pb-Free (RoHS) | CU NIPDAU | N / A for Pkg Type | -40 to 85 | TL594IN | Samples |
| TL594INSR | ACTIVE | SO | NS | 16 | 2000 | Green (RoHS & no Sb/Br) | CU NIPDAU | Level-1-260C-UNLIM | -40 to 85 | TL594I | Samples |
| TL594INSRG4 | ACTIVE | SO | NS | 16 | 2000 | Green (RoHS & no Sb/Br) | CU NIPDAU | Level-1-260C-UNLIM | -40 to 85 | TL594I | Samples |
| TL594IPWR | ACTIVE | TSSOP | PW | 16 | 2000 | Green (RoHS & no Sb/Br) | CU NIPDAU | Level-1-260C-UNLIM | -40 to 85 | Z594 | Samples |
| TL594IPWRE4 | ACTIVE | TSSOP | PW | 16 | 2000 | Green (RoHS & no Sb/Br) | CU NIPDAU | Level-1-260C-UNLIM | -40 to 85 | Z594 | Samples |
| TL594IPWRG4 | ACTIVE | TSSOP | PW | 16 | 2000 | Green (RoHS & no Sb/Br) | CU NIPDAU | Level-1-260C-UNLIM | -40 to 85 | Z594 | Samples |

(1) The marketing status values are defined as follows:

ACTIVE: Product device recommended for new designs.

LIFEBUY: TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

NRND: Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

PREVIEW: Device has been announced but is not in production. Samples may or may not be available.

OBSOLETE: TI has discontinued the production of the device.

(2) Eco Plan - The planned eco-friendly classification: Pb-Free (RoHS), Pb-Free (RoHS Exempt), or Green (RoHS & no Sb/Br) - please check <http://www.ti.com/productcontent> for the latest availability information and additional product content details.

TBD: The Pb-Free/Green conversion plan has not been defined.

Pb-Free (RoHS): TI's terms "Lead-Free" or "Pb-Free" mean semiconductor products that are compatible with the current RoHS requirements for all 6 substances, including the requirement that lead not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, TI Pb-Free products are suitable for use in specified lead-free processes.

Pb-Free (RoHS Exempt): This component has a RoHS exemption for either 1) lead-based flip-chip solder bumps used between the die and package, or 2) lead-based die adhesive used between the die and leadframe. The component is otherwise considered Pb-Free (RoHS compatible) as defined above.

Green (RoHS & no Sb/Br): TI defines "Green" to mean Pb-Free (RoHS compatible), and free of Bromine (Br) and Antimony (Sb) based flame retardants (Br or Sb do not exceed 0.1% by weight in homogeneous material)

(3) MSL, Peak Temp. -- The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.

(4) Multiple Top-Side Markings will be inside parentheses. Only one Top-Side Marking contained in parentheses and separated by a "~" will appear on a device. If a line is indented then it is a continuation of the previous line and the two combined represent the entire Top-Side Marking for that device.

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In no event shall TI's liability arising out of such information exceed the total purchase price of the TI part(s) at issue in this document sold by TI to Customer on an annual basis.

TAPE AND REEL INFORMATION


*All dimensions are nominal

| Device | Package Type | Package Drawing | Pins | SPQ | Reel Diameter (mm) | Reel Width W1 (mm) | A0 (mm) | B0 (mm) | K0 (mm) | P1 (mm) | W (mm) | Pin1 Quadrant |
|------------|--------------|-----------------|------|------|--------------------|--------------------|---------|---------|---------|---------|--------|---------------|
| TL594CDR | SOIC | D | 16 | 2500 | 330.0 | 16.8 | 6.5 | 10.3 | 2.1 | 8.0 | 16.0 | Q1 |
| TL594CDRG4 | SOIC | D | 16 | 2500 | 330.0 | 16.4 | 6.5 | 10.3 | 2.1 | 8.0 | 16.0 | Q1 |
| TL594CPWR | TSSOP | PW | 16 | 2000 | 330.0 | 12.4 | 6.9 | 5.6 | 1.6 | 8.0 | 12.0 | Q1 |
| TL594IDR | SOIC | D | 16 | 2500 | 330.0 | 16.4 | 6.5 | 10.3 | 2.1 | 8.0 | 16.0 | Q1 |
| TL594IPWR | TSSOP | PW | 16 | 2000 | 330.0 | 12.4 | 6.9 | 5.6 | 1.6 | 8.0 | 12.0 | Q1 |

TAPE AND REEL BOX DIMENSIONS



*All dimensions are nominal

| Device | Package Type | Package Drawing | Pins | SPQ | Length (mm) | Width (mm) | Height (mm) |
|------------|--------------|-----------------|------|------|-------------|------------|-------------|
| TL594CDR | SOIC | D | 16 | 2500 | 364.0 | 364.0 | 27.0 |
| TL594CDRG4 | SOIC | D | 16 | 2500 | 333.2 | 345.9 | 28.6 |
| TL594CPWR | TSSOP | PW | 16 | 2000 | 367.0 | 367.0 | 35.0 |
| TL594IDR | SOIC | D | 16 | 2500 | 333.2 | 345.9 | 28.6 |
| TL594IPWR | TSSOP | PW | 16 | 2000 | 367.0 | 367.0 | 35.0 |

N (R-PDIP-T**)

16 PINS SHOWN

PLASTIC DUAL-IN-LINE PACKAGE



| PINS ** DIM | 14 | 16 | 18 | 20 |
|---------------------|------------------|------------------|------------------|------------------|
| A MAX | 0.775 (19,69) | 0.775 (19,69) | 0.920 (23,37) | 1.060 (26,92) |
| A MIN | 0.745 (18,92) | 0.745 (18,92) | 0.850 (21,59) | 0.940 (23,88) |
| MS-001 VARIATION | AA | BB | AC | AD |



4040049/E 12/2002

NOTES:

- A. All linear dimensions are in inches (millimeters).
B. This drawing is subject to change without notice.
-  Falls within JEDEC MS-001, except 18 and 20 pin minimum body length (Dim A).
 The 20 pin end lead shoulder width is a vendor option, either half or full width.

D (R-PDSO-G16)

PLASTIC SMALL OUTLINE



4040047-6/M 06/11

- NOTES:
- A. All linear dimensions are in inches (millimeters).
 - B. This drawing is subject to change without notice.
 - C. Body length does not include mold flash, protrusions, or gate burrs. Mold flash, protrusions, or gate burrs shall not exceed 0.006 (0,15) each side.
 - D. Body width does not include interlead flash. Interlead flash shall not exceed 0.017 (0,43) each side.
 - E. Reference JEDEC MS-012 variation AC.

D (R-PDSO-G16)

PLASTIC SMALL OUTLINE



- NOTES:
- All linear dimensions are in millimeters.
 - This drawing is subject to change without notice.
 - Publication IPC-7351 is recommended for alternate designs.
 - Laser cutting apertures with trapezoidal walls and also rounding corners will offer better paste release. Customers should contact their board assembly site for stencil design recommendations. Refer to IPC-7525 for other stencil recommendations.
 - Customers should contact their board fabrication site for solder mask tolerances between and around signal pads.

PW (R-PDSO-G16)

PLASTIC SMALL OUTLINE



4040064-4/G 02/11

- NOTES:
- A. All linear dimensions are in millimeters. Dimensioning and tolerancing per ASME Y14.5M-1994.
 - B. This drawing is subject to change without notice.
 - C. Body length does not include mold flash, protrusions, or gate burrs. Mold flash, protrusions, or gate burrs shall not exceed 0,15 each side.
 - D. Body width does not include interlead flash. Interlead flash shall not exceed 0,25 each side.
 - E. Falls within JEDEC MO-153

PW (R-PDSO-G16)

PLASTIC SMALL OUTLINE



4211284-3/F 12/12

- NOTES:
- A. All linear dimensions are in millimeters.
 - B. This drawing is subject to change without notice.
 - C. Publication IPC-7351 is recommended for alternate designs.
 - D. Laser cutting apertures with trapezoidal walls and also rounding corners will offer better paste release. Customers should contact their board assembly site for stencil design recommendations. Refer to IPC-7525 for other stencil recommendations.
 - E. Customers should contact their board fabrication site for solder mask tolerances between and around signal pads.

MECHANICAL DATA

NS (R-PDSO-G**)

PLASTIC SMALL-OUTLINE PACKAGE

14-PINS SHOWN



| DIM \ PINS ** | 14 | 16 | 20 | 24 |
|---------------|-------|-------|-------|-------|
| A MAX | 10,50 | 10,50 | 12,90 | 15,30 |
| A MIN | 9,90 | 9,90 | 12,30 | 14,70 |

4040062/C 03/03

- NOTES:
- A. All linear dimensions are in millimeters.
 - B. This drawing is subject to change without notice.
 - C. Body dimensions do not include mold flash or protrusion, not to exceed 0,15.

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